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### FTM3725

### **NPN Transistor**

- This device is designed for high current, low impedance line driver applications.
- Sourced from process 26.



### **Absolute Maximum Ratings\*** $T_a$ =25°C unless otherwise noted

Symbol	Parameter	Value	Units	
V <sub>CEO</sub>	Collector-Emitter Voltage	40	V	
V <sub>CBO</sub>	Collector-Base Voltage	60	V	
V <sub>EBO</sub>	Emitter-Base Voltage	6.0	V	
I <sub>C</sub>	Collector Current - Continuous	1.2	Α	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	- 55 ~ 150	°C	

<sup>\*</sup> These ratings are limiting values above whitch the serviceability of any semiconductor device may be impaird.

- These ratings are based on a maximum junction temperature of 150 degrees C.
  These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

### Electrical Characteristics T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charac	teristics				•	
V <sub>(BR)CEO</sub>	Collector-Emitter Breakdown Voltage *	I <sub>C</sub> = 10mA, I <sub>B</sub> = 0	40			V
V <sub>(BR)CES</sub>	Collector-Emitter Breakdown Voltage	$I_C = 10\mu A, V_{BE} = 0$	60			V
V <sub>(BR)CBO</sub>	Collector-Base Breakdown Voltage	$I_C = 10\mu A, I_E = 0$	60			V
V <sub>(BR)EBO</sub>	Emitter-Base Breakdown Voltage	$I_E = 10\mu A, I_C = 0$	6.0			V
I <sub>CBO</sub>	Collector Cutoff Current	$V_{CB} = 50V, I_{E} = 0$ $V_{CB} = 50V, I_{E} = 0, T_{a} = 100^{\circ}C$			100 10	nA μA
On Charac	teristics *			•		
h <sub>FE</sub>	DC Current Gain	$\begin{split} &I_C = 10\text{mA},  V_{CE} = 1.0\text{V} \\ &I_C = 100\text{mA},  V_{CE} = 1.0\text{V} \\ &I_C = 100\text{mA},  V_{CE} = 1.0\text{V},  T_a = 55^{\circ}\text{C} \\ &I_C = 300\text{mA},  V_{CE} = 1.0\text{V} \\ &I_C = 500\text{mA},  V_{CE} = 1.0\text{V} \\ &I_C = 500\text{mA},  V_{CE} = 1.0\text{V},  T_a = 55^{\circ}\text{C} \\ &I_C = 800\text{mA},  V_{CE} = 2.0\text{V} \\ &I_C = 1.0\text{mA},  V_{CE} = 5.0\text{V} \end{split}$	30 60 30 40 35 20 20 25		180	
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	$\begin{split} &I_{C} = 10\text{mA},\ I_{B} = 1.0\text{mA} \\ &I_{C} = 100\text{mA},\ I_{B} = 10\text{mA} \\ &I_{C} = 300\text{mA},\ I_{B} = 30\text{mA} \\ &I_{C} = 500\text{mA},\ I_{B} = 50\text{mA} \\ &I_{C} = 800\text{mA},\ I_{B} = 80\text{mA} \\ &I_{C} = 1.0\text{mA},\ I_{B} = 100\text{mA} \end{split}$			0.25 0.26 0.4 0.52 0.8 0.95	V V V V
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage	$\begin{split} &I_C = 10\text{mA},\ I_B = 1.0\text{mA} \\ &I_C = 100\text{mA},\ I_B = 10\text{mA} \\ &I_C = 300\text{mA},\ I_B = 30\text{mA} \\ &I_C = 500\text{mA},\ I_B = 50\text{mA} \\ &I_C = 800\text{mA},\ I_B = 80\text{mA} \\ &I_C = 1.0\text{mA},\ I_B = 100\text{mA} \end{split}$			0.76 0.86 1.1 1.2 1.5 1.7	V V V V V

# $\textbf{Electrical Characteristics*} \text{ (Continued) } \textbf{T}_{a} = 25^{\circ} \textbf{C unless otherwise noted}$

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Small Sign	Small Signal Characteristics					
f <sub>T</sub>	Current Gain Bandwidth Product	I <sub>C</sub> = 50mA, V <sub>CE</sub> = 10V, f = 100MHz	250			MHz
C <sub>obo</sub>	Output Capacitance	$V_{CB} = 10V, I_E = 0, f = 1.0MHz$			15	pF
C <sub>ibo</sub>	Input Capacitance	$V_{EB} = 0.5V, I_{C} = 0, f = 1.0MHz$			65	pF
Switching Characteristics						
t <sub>on</sub>	Turn-on Time	$V_{CC} = 30V, V_{BE} = 3.8V$		20		ns
t <sub>d</sub>	Delay Time	I <sub>C</sub> = 500mA, I <sub>B1</sub> = 50mA		10		ns
t <sub>r</sub>	Rise Time			12		ns
t <sub>off</sub>	Turn-off Time	$V_{CC} = 30V, I_{C} = 500mA$		250		ns
t <sub>s</sub>	Storage Time	$I_{B1} = I_{B2} = 50 \text{mA}$		235		ns
t <sub>f</sub>	Fall Time			15		ns

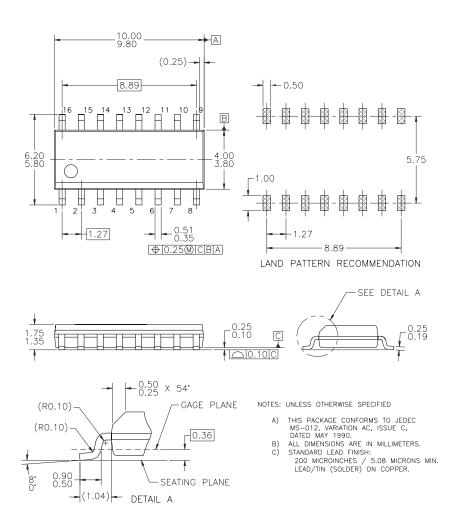
<sup>\*</sup> Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 1.0%

### Thermal Characteristics $T_a=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Max.	Units
P <sub>D</sub>	Total Device Dissipation	1.0	W
_	Derate above 25°C	8.0	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient		
	Effectine 4 Die	125	°C/W
	Each Die	240	°C/W

# **Package Dimensions**

# SOIC-16



Dimensions in Millimeters

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#### **Definition of Terms**

Datasheet Identification	Product Status	Definition
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